

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	120	(264/619).CCLS.	USPAT; USOCR	OR	OFF	2006/09/21 10:21
S2	40	S1 and screen print\$3	US-PGPUB; USPAT	ADJ	OFF	2006/09/21 10:23
S3	2143	(428/901).CCLS.	USPAT; USOCR	OR	OFF	2006/09/21 10:36
S4	78	(427/97.1).CCLS.	USPAT; USOCR	OR	OFF	2006/09/21 10:39
S5	2153	S3 or S4 and screen print\$3	US-PGPUB; USPAT; USOCR; EPO	ADJ	OFF	2006/09/21 10:39
S6	2147	S3 or S4 and screen print\$3 and ceramic	US-PGPUB; USPAT; USOCR; EPO	ADJ	OFF	2006/09/21 10:39
S7	2143	S3 or S4 and screen print\$3 and ceramic and antenna	US-PGPUB; USPAT; USOCR; EPO	ADJ	OFF	2006/09/21 10:41
S9	523	S7 and screen print\$3	US-PGPUB; USPAT; USOCR; EPO	ADJ	OFF	2006/09/21 10:46
S11	3214	((264/619,614,642,650) or (428/901) or (427/97.1)).CCLS.	US-PGPUB; USPAT; USOCR; EPO	OR	OFF	2006/09/21 10:53
S12	694	S11 and screen print\$3	US-PGPUB; USPAT; USOCR; EPO	ADJ	OFF	2006/09/21 10:55
S14	28	264/650.ccls. and screen print\$3	US-PGPUB; USPAT; USOCR; EPO	ADJ	OFF	2006/09/21 11:17
S18	139	(264/619).CCLS.	US-PGPUB; USPAT; USOCR; EPO	OR	OFF	2006/09/21 11:34
S19	3838	(427/97.3,258,265,282,269).CCLS.	US-PGPUB; USPAT; USOCR; EPO	OR	OFF	2006/09/21 11:34

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S20	570	S19 and screen print\$3	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/21 11:38
S21	2041	427/282.ccls.	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/21 11:39
S22	341	S21 and screen print\$3	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/21 11:39
S23	4214	((264/619,614,642,650) or (427/258,265,282)).CCLS.	US-PGPUB; USPAT; USOCR; EPO	OR	OFF	2006/09/21 11:39
S24	3404	((264/619,614,642,650) or (427/258,265,282)).CCLS.	US-PGPUB; USPAT	OR	OFF	2006/09/25 07:52
S25	606	S24 and screen print\$3	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/21 11:41
S34	1998	multi layer ceramic	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/22 13:41
S35	0	S34 and stress mitigat\$	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/22 13:41
S36	694	S34 and stress	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/22 13:42
S37	8	ceramic substrate and stress mitigating	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/22 13:42
S38	36	("4357526" "4550245" "4755654" "4804823" "4873151" "4912305" "4965659" "5070701" "5142650" "5188286" "5231690" "5280156" "5306695" "5490228").PN. OR ("5683606"). URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2006/09/22 13:50
S39	17	S38 and stress	US-PGPUB; USPAT; USOCR	ADJ	ON	2006/09/22 13:50

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S44	13963	ceramic substrate and pressure	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/22 14:05
S45	266	ceramic substrate and pressure with (plane or planerization)	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/22 14:06
S46	266	ceramic substrate and pressure with (plane or planerizationor planerize)	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/22 14:07
S47	871	ceramic substrate and pressure same (plane or planerizationor planerize)	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/22 14:06
S48	214	electric\$2 and ceramic substrate and pressure with (plane or planerizationor planerize)	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/22 14:07
S49	35	electric\$2 circuit and ceramic substrate and pressure with (plane or planerizationor planerize)	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/22 14:09
S54	3404	((264/619,614,642,650) or (427/258,265,282)).CCLS.	US-PGPUB; USPAT	OR	OFF	2006/09/25 07:52
S55	15	S54 and pressurize	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/25 07:52
S56	5	ceramic and stress mitigating layer	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/25 08:09
S58	184	multilayer ceramic substrate and resistor and capacitor	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/25 08:10
S60	1258	screen print\$3 and pressur\$3 with plan\$5	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/25 08:36
S61	612	screen print\$3 and pressur\$3 with plan\$5 and ceramic	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/25 08:36

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S62	122	screen print\$3 and pressur\$3 with plan\$5 and ceramic substrate	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/25 08:43
S63	28	screen print\$3 and pressur\$3 with plan\$5 and ceramic substrate and conduct\$3 layer	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/25 11:48
S64	5	ceramic and stress mitigating (layer or region)	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/25 11:48
S65	24907	pressur\$3 near3 plan\$5	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/25 16:09
S66	9924	conduct\$3 layer same pressur\$3	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/25 16:10
S67	3538	conduct\$3 layer with pressur\$3	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/25 16:10
S68	7	conduct\$3 layer with (pressur\$3 near3 plan\$5)	US-PGPUB; USPAT; USOCR; EPO	ADJ	ON	2006/09/25 16:11